

HCPL-3100

Power MOSFET/IGBT Gate Drive Optocouplers

Avago
TECHNOLOGIES

Data Sheet

HCPL-3100, HCPL-3101

Description

The HCPL-3100/3101 consists of an LED* optically coupled to an integrated circuit with a power output stage. These optocouplers are suited for driving power MOSFETs and IGBTs used in motor control inverter applications. The high operating voltage range of the output stage provides the voltage drives required by gate controlled devices. The voltage and current supplied by these optocouplers allow for direct interfacing to the power device without the need for an intermediate amplifier stage.

The HCPL-3100 switches a 3000 pF load in 2 µs and the HCPL-3101, using a higher speed LED, switches a 3000 pF load in 0.5 µs. With a CMR rating of 15 kV/µs typical these opto-couplers readily reject transients found in inverter applications.

The LED controls the state of the output stage. Transistor Q2 in the output stage is on with the LED off, allowing the gate of the power device to be held low. Turning on the LED turns off transistor Q2 and switches on transistor Q1 in the output stage which provides current and voltage to drive the gate of the power device.

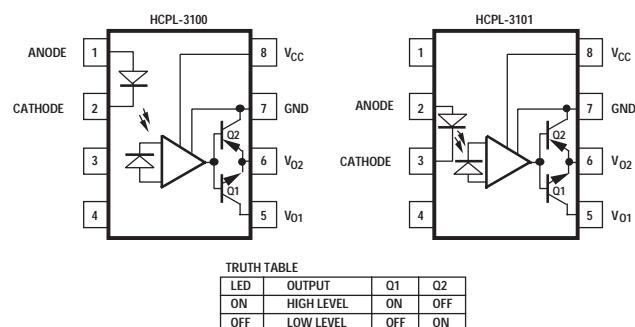
Features

- High output current I_{O1} and I_{O2} (0.6 A Peak, 0.1 A continuous)
- 15 kV/µs minimum Common Mode Rejection (CMR) at $V_{CM} = 1500$ V
- Wide operating V_{CC} range (15 to 30 volts)
- High speed
 - 1 µs typical propagation delay (HCPL-3100)
 - 0.3 µs typical propagation delay (HCPL-3101)
- Recognized under UL 1577 for dielectric withstand proof test voltages of 5000 vac, 1 minute

Applications

- Isolated MOSFET/IGBT gate drive
- AC and DC motor drives
- General purpose industrial inverters
- Uninterruptable power supply

Functional Diagram

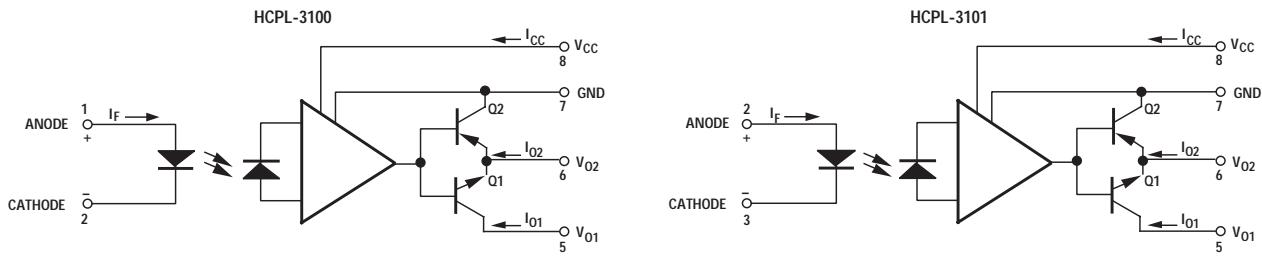


THE USE OF A 0.1 µF BYPASS CAPACITOR CONNECTED BETWEEN PINS 8 AND 7 IS RECOMMENDED. ALSO CURRENT LIMITING RESISTOR IS RECOMMENDED (SEE FIGURE 1, AND NOTE 2 AND NOTE 7).

*HCPL-3100 LED contains Silicon-doped GaAs and HCPL-3101 LED contains AlGaAs.

CAUTION: It is advised that normal static precautions be taken in handling and assembly of this component to prevent damage and/or degradation which may be induced by ESD.

Schematic



THE USE OF A 0.1 μ F BYPASS CAPACITOR CONNECTED BETWEEN PINS 8 AND 7 IS RECOMMENDED. ALSO CURRENT LIMITING RESISTOR IS RECOMMENDED (SEE FIGURE 1, AND NOTE 2 AND NOTE 7).

Ordering Information

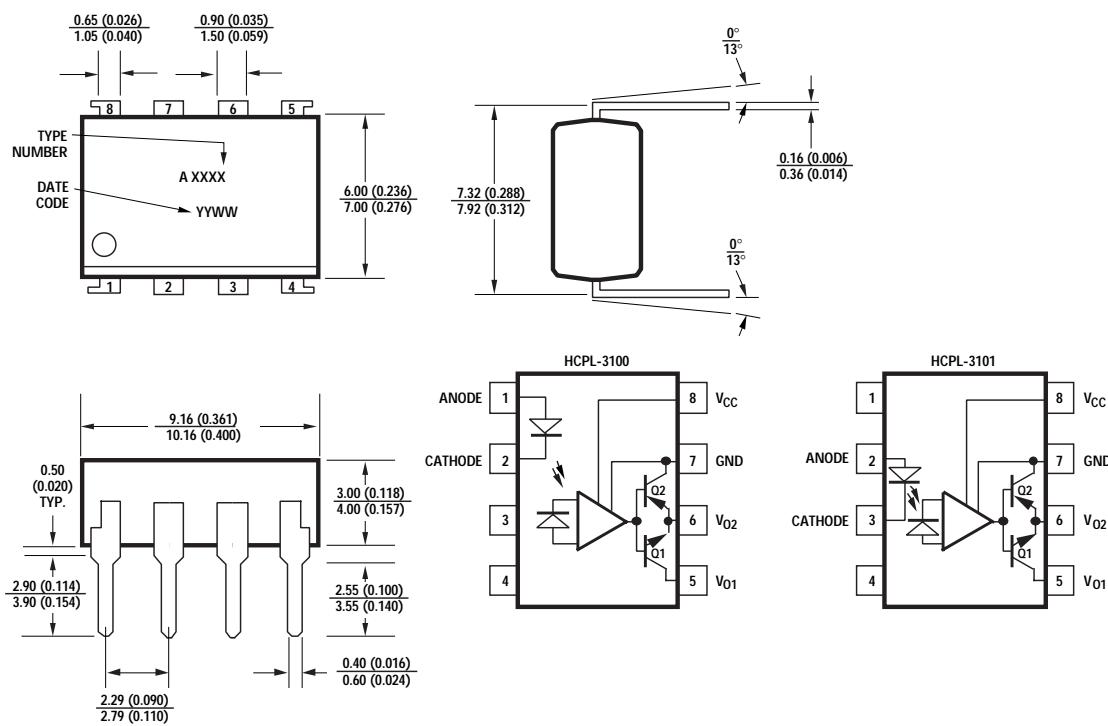
Specify Part Number followed by Option Number (if desired).

Example:

HCPL-310x-XXX E

- Lead-free.
- 000 = Standard DIP Package, 50 per tube.
- 300 = Gull Wing Surface Mount Option, 50 per tube.
- 500 = Tape and Reel Packaging Option, 1000 per reel.

Outline Drawing



Demonstrated ESD Performance

Human Body Model: MIL-STD-883 Method 3015.7: Class 2

Machine Model: EIAJ IC-121-1988 (1988.3.28 Version 2), Test Method 20, Condition C: 1200 V

Regulatory Information

The HCPL-3100/3101 has been approved by the following organization:

UL

Recognized under UL 1577, Component Recognition Program, File E55361.

Insulation and Safety Related Specifications

| Parameter | Symbol | Value | Units | Conditions |
|---|--------|-------|-------|--|
| Min. External Air Gap (External Clearance) | L(I01) | 6.0 | mm | Shortest distance measured through air, between two conductive leads, input to output |
| Min. External Tracking Path (External Creepage) | L(I02) | 6.0 | mm | Shortest distance path measured along outside surface of optocoupler body between input and output leads |
| Min. Internal Plastic Gap (Internal Clearance) | | 0.15 | mm | Through insulation distance conductor to conductor inside the optocoupler cavity |

Absolute Maximum Ratings

| Parameter | Symbol | Device | Min. | Max. | Unit | Conditions | Fig. | Note |
|--------------------------------|--------------------|-----------------|--|------|------|--|------|------|
| Storage Temperature | T _S | | -55 | 125 | °C | | | |
| Operating Temperature | T _A | HCPL-3100 | -40 | 100 | °C | | | |
| | | HCPL-3101 | -40 | 85 | | | | |
| Input | Continuous Current | I _F | HCPL-3100 | 25 | mA | | 11 | 1 |
| | | | HCPL-3101 | 20 | mA | | 11 | 1 |
| | Reverse Voltage | V _R | HCPL-3100 | 6 | V | T _A = 25°C | | |
| | | | HCPL-3101 | 5 | | | | |
| Supply Voltage V _{CC} | | | 35 | V | | | | |
| Output 1 | Continuous Current | I _{O1} | | 0.1 | A | | | 1 |
| | Peak Current | | | 0.6 | A | Pulse Width < 0.15 μs, Duty cycle = 1% | | 1 |
| | Voltage | V _{O1} | | 35 | V | | | |
| Output 2 | Continuous Current | I _{O2} | | 0.1 | A | | | 1 |
| | Peak Current | | | 0.6 | A | Pulse Width < 0.15 μs, Duty cycle = 1% | | 1 |
| Output Power Dissipation | P _O | | 500 | mW | | | 12 | 1 |
| Total Power Dissipation | P _T | | 550 | mW | | | 12 | 1 |
| Lead Solder Temperature | | | 270°C for 10 s, 1.0 mm below seating plane | | | | | |

Recommended Operating Conditions

| Parameter | Symbol | Device | Min. | Max. | Units |
|-----------------------|----------|-----------|------|------|-------|
| Power Supply Voltage | V_{CC} | | 15 | 30 | V |
| Input Current (ON) | I_F | HCPL-3100 | 14 | 20 | mA |
| | | HCPL-3101 | 15 | 20 | mA |
| Operating Temperature | T_A | | -40 | 70 | °C |

Recommended Protection for Output Transistors

During switching transitions, the output transistors Q1 and Q2 of the HCPL-3100/3101 can conduct large amounts of current. Figure 1 describes a

recommended circuit design showing a current limiting resistor R_2 which is necessary in order to prevent damage to the output transistors Q1 and Q2. (See Note 7.) A bypass capacitor C_1 is also recommended to reduce power supply noise.

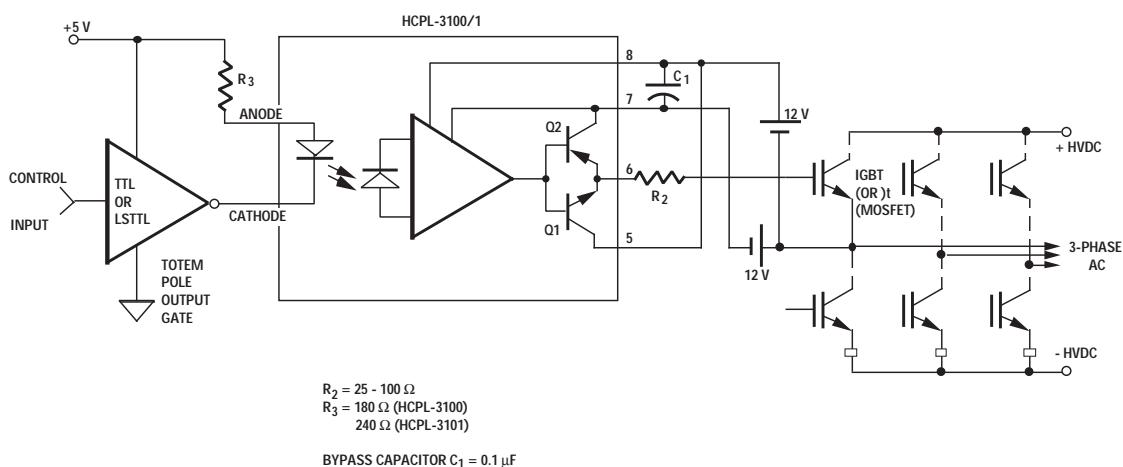


Figure 1. Recommended output transistor protection and typical application circuit.

Electrical Specifications

Over recommended temperature ($T_A = -40^\circ\text{C}$ to $+100^\circ\text{C}$, HCPL-3100; $T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$, HCPL-3101) unless otherwise specified.

| Parameter | | Sym. | Device | Min. | Typ. | Max. | Units | Test Conditions | | Fig. | Note | |
|-----------------------------|--------------------|------------------|-----------|------|------|------|-------|---|--|--------------|------|--|
| Input Forward Voltage | | V _F | HCPL-3100 | - | 1.2 | 1.4 | V | I _F = 20 mA | T _A = 25°C | 13 | | |
| | | | | 0.6 | 0.9 | - | V | I _F = 0.2 mA | | | | |
| | | HCPL-3101 | HCPL-3101 | - | 1.6 | 1.75 | V | I _F = 10 mA | T _A = 25°C | 14 | | |
| | | | | 1.2 | 1.5 | - | V | I _F = 0.2 mA | | | | |
| Input Reverse Current | | I _R | HCPL-3100 | - | - | 10 | μA | V _R = 4 V | T _A = 25°C | | | |
| | | | | | | | | V _F = 5 V | | | | |
| Input Capacitance | | C _{IN} | HCPL-3100 | - | 30 | 250 | pF | V _F = 0 V, f = 1 kHz, T _A = 25°C | | | | |
| | | | | - | 60 | 150 | pF | V _F = 0 V, f = 1 MHz, T _A = 25°C | | | | |
| Output 1 | Low Level Voltage | V _{O1L} | HCPL-3100 | - | 0.2 | 0.4 | V | I _F = 10 mA | V _{CC1} = 12 V, I _{O1} = 0.1 A, V _{CC2} = -12 V | 2, 17, 18 | 2 | |
| | | | | | | | | I _F = 5 mA | | | | |
| | Leakage Current | I _{O1L} | | - | - | 500 | μA | V _{CC} = V _{O1} = 35 V, V _{O2} = 0 V I _F = 0 mA, T _A = 25°C | | 5 | | |
| Output 2 | High Level Voltage | V _{O2H} | HCPL-3100 | 20 | 22 | - | V | I _F = 10 mA | V _{CC} = 24 V, V _{O1} = 24 V, I _{O2} = -0.1 A | 3, 19, 20 | 2 | |
| | | | | | | | | I _F = 5 mA | | | | |
| | Low Level Voltage | V _{O2L} | | - | 0.5 | 0.8 | V | V _{CC} = V _{O1} = 24 V, I _{O2} = 0.1 A, I _F = 0 mA | 4, 21, 22 | | | |
| | Leakage Current | I _{O2L} | HCPL-3100 | - | - | 500 | μA | I _F = 10 mA | V _{CC} = 35 V, V _{O2} = 35 V, T _A = 25°C | 6 | | |
| | | | | | | | | I _F = 5 mA | | | | |
| Supply Current | High Level | I _{CCH} | HCPL-3100 | - | 1.3 | 3.0 | mA | V _{O1} = 24 V V _{CC} = 24 V, I _F = 10 mA | | 7, 23 | 2 | |
| | | | | - | 1.3 | 3.0 | mA | V _{O1} = 24 V V _{CC} = 24 V, I _F = 5 mA | | | | |
| | Low Level | I _{CCL} | | - | 1.3 | 3.0 | mA | V _{O1} = 24 V V _{CC} = 24 V, I _F = 0 mA | | 7, 24 | | |
| Low to High Threshold Input | | I _{FLH} | HCPL-3100 | 1.0 | 4.0 | 7.0 | mA | T _A = 25°C | | 8, 15, 16 | 2, 3 | |
| | | | | 0.6 | - | 10.0 | mA | V _{CC} = V _{O1} = 24 V | | | | |
| | | | HCPL-3101 | 0.3 | 1.5 | 3.0 | mA | T _A = 25°C | | | | |
| | | | | 0.2 | - | 5.0 | mA | V _{CC} = V _{O1} = 24 V | | | | |

Switching Specifications ($T_A = 25^\circ\text{C}$)

| Parameter | Sym. | Device | Min. | Typ. | Max. | Units | Test Conditions | | Fig. | Note |
|--|-----------|-----------|------|------|------|-------------------------|-----------------------|---|------------------------|------|
| Propagation Delay Time to High Output Level | t_{PLH} | HCPL-3100 | - | 1 | 2 | μs | $I_F = 10 \text{ mA}$ | $V_{CC} = 24 \text{ V}$, $V_{O1} = 24 \text{ V}$, $R_G = 47 \Omega$, $C_G = 3000 \text{ pF}$ | 9, 25, 26, 27 | 2, 6 |
| | | HCPL-3101 | - | 0.3 | 0.5 | μs | $I_F = 5 \text{ mA}$ | | | |
| Propagation Delay Time to Low Output Level | t_{PHL} | HCPL-3100 | - | 1 | 2 | μs | $I_F = 10 \text{ mA}$ | $V_{CC} = 24 \text{ V}$, $V_{O1} = 24 \text{ V}$, $R_G = 47 \Omega$, $C_G = 3000 \text{ pF}$ | 9, 25, 26, 27 | 2, 6 |
| | | HCPL-3101 | - | 0.3 | 0.5 | μs | $I_F = 5 \text{ mA}$ | | | |
| Rise Time | t_r | HCPL-3100 | - | 0.2 | 0.5 | μs | $I_F = 10 \text{ mA}$ | $V_{CC} = 24 \text{ V}$, $V_{O1} = 24 \text{ V}$, $R_G = 47 \Omega$, $C_G = 3000 \text{ pF}$ | 9, 25, 26, 27 | 2, 6 |
| | | HCPL-3101 | - | | | | $I_F = 5 \text{ mA}$ | | | |
| Fall Time | t_f | HCPL-3100 | - | 0.2 | 0.5 | μs | $I_F = 10 \text{ mA}$ | $V_{CC} = 24 \text{ V}$, $V_{O1} = 24 \text{ V}$, $R_G = 47 \Omega$, $C_G = 3000 \text{ pF}$ | 9, 25, 26, 27 | 2, 6 |
| | | HCPL-3101 | - | | | | $I_F = 5 \text{ mA}$ | | | |
| Output High Level Common Mode Transient Immunity | $ CM_H $ | HCPL-3100 | 15 | | - | $\text{kV}/\mu\text{s}$ | $I_F = 10 \text{ mA}$ | $V_{CM} = 1500 \text{ V}$ (peak), $V_{CC} = 24 \text{ V}$, $V_{O1} = 24 \text{ V}$, $\Delta V_{O2H} = \Delta V_{O2L} = 2.0 \text{ V}$ | 10 | 2 |
| | | HCPL-3101 | | | | | $I_F = 5 \text{ mA}$ | | | |
| Output Low Level Common Mode Transient Immunity | $ CM_L $ | | 15 | | - | $\text{kV}/\mu\text{s}$ | $I_F = 0 \text{ mA}$ | $V_{CM} = 1500 \text{ V}$ (peak), $V_{CC} = 24 \text{ V}$, $V_{O1} = 24 \text{ V}$, $\Delta V_{O2H} = \Delta V_{O2L} = 2.0 \text{ V}$ | 10 | 2 |

Packaging Characteristics

| Parameter | Sym. | Min. | Typ. | Max. | Units | Test Conditions | Fig. | Note |
|---|-----------|--------------------|-----------|------|----------|---|------|------|
| Input-Output Momentary Withstand Voltage* | V_{ISO} | 5000 | | | V rms | $RH = 40\% \text{ to } 60\%$ $t = 1 \text{ min}, T_A = 25^\circ\text{C}$ | | 4, 5 |
| Resistance (Input-Output) | R_{I-O} | 5×10^{10} | 10^{11} | - | Ω | $V_{I-O} = 500 \text{ V}, T_A = 25^\circ\text{C}$ $RH = 40\% \text{ to } 60\%$ | | 4 |
| Capacitance (Input-Output) | C_{I-O} | - | 1.2 | - | pF | $f = 1 \text{ MHz}$ | | 4 |

*The Input-Output Momentary Withstand Voltage is a dielectric voltage rating that should not be interpreted as an input-output continuous voltage rating. For the continuous voltage rating refer to the IEC/EN/DIN EN 60747-5-2 Insulation Characteristics Table (if applicable), your equipment level safety specification, or Avago Application Note 1074, "Optocoupler Input-Output Endurance Voltage."

Notes:

- Derate absolute maximum ratings with ambient temperatures as shown in Figures 11 and 12.
- A bypass capacitor of 0.01 μF or more is needed near the device between V_{CC} and GND when measuring output and transfer characteristics.
- I_{FLH} represents the forward current when the output goes from low to high.
- Device considered a two terminal device; pins 1-4 are shorted together and pins 5-8 are shorted together.
- For devices with minimum V_{ISO} specified at 5000 V rms, in accordance with UL 1577, each optocoupler is proof-tested by applying an insulation test voltage $\geq 6000 \text{ V}$ rms for one second (leakage current detection limit, $I_{I-O} \leq 200 \mu\text{A}$).
- The t_{PLH} and t_{PHL} propagation delays are measured from the 50% level of the input pulse to the 50% level of the output pulse.
- R_2 limits the Q1 and Q2 peak currents. For more applications and circuit design information see Application Note "Power Transistor Gate/Base Drive Optocouplers."

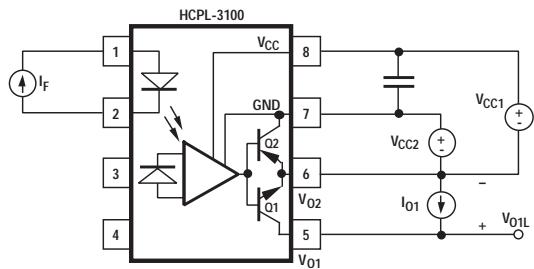


Figure 2. Test circuit for low level output voltage V_{O1L} .

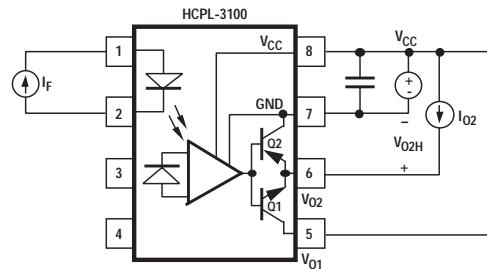


Figure 3. Test circuit for high level output voltage V_{O2H} .

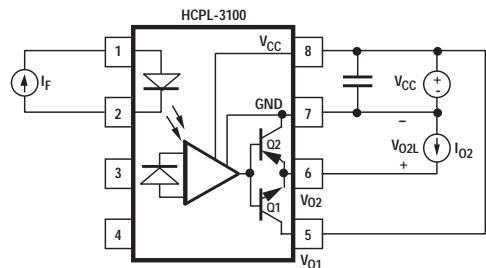


Figure 4. Test circuit for low level output voltage V_{O2L} .

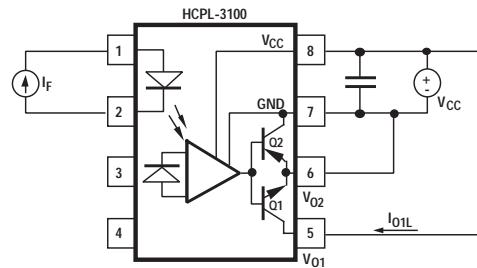


Figure 5. Test circuit for leakage current I_{O1L} .

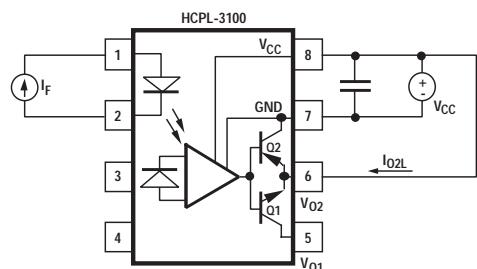


Figure 6. Test circuit for leakage current I_{O2L} .

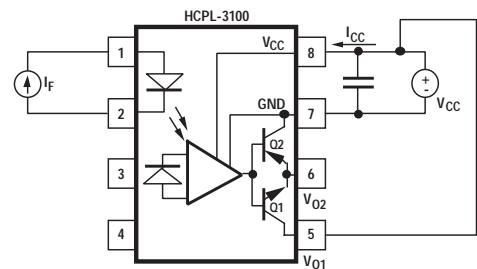


Figure 7. Test circuit for I_{CCH} and I_{CCL} .

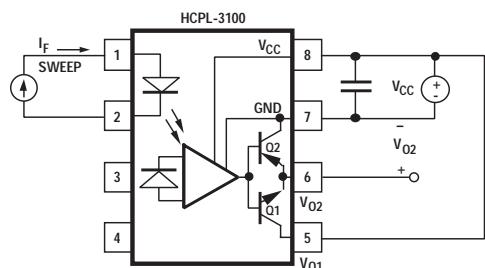


Figure 8. Test circuit for threshold input current I_{FLH} .

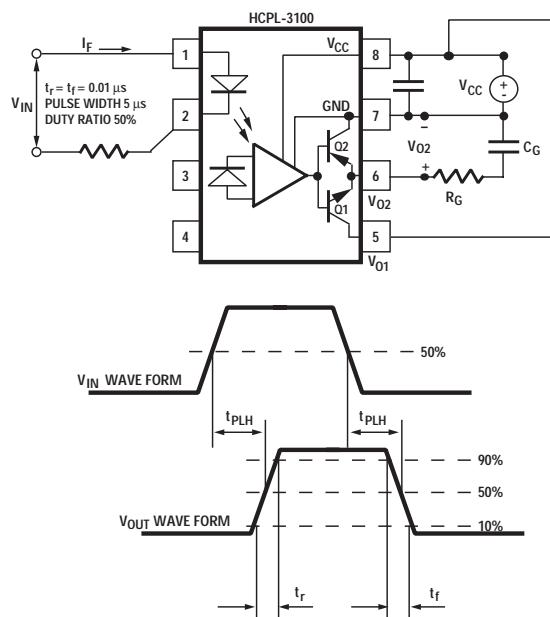


Figure 9. Test circuit for t_{PLH} , t_{PHL} , t_r , and t_f .

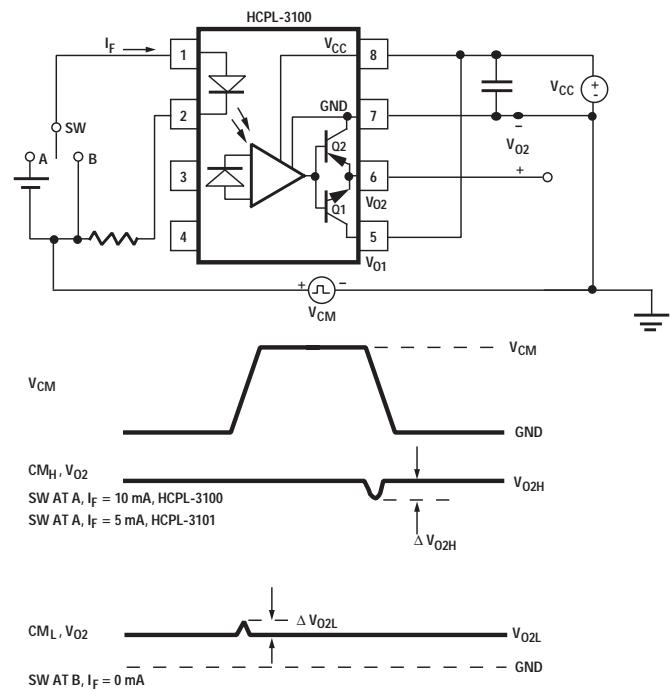


Figure 10. Test circuit for CM_H and CM_L .

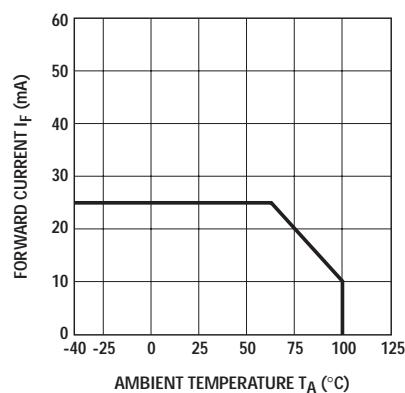


Figure 11. LED forward current vs. ambient temperature, HCPL-3100.

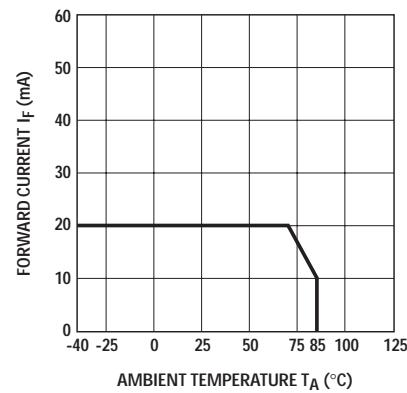


Figure 12. LED forward current vs. ambient temperature, HCPL-3101.

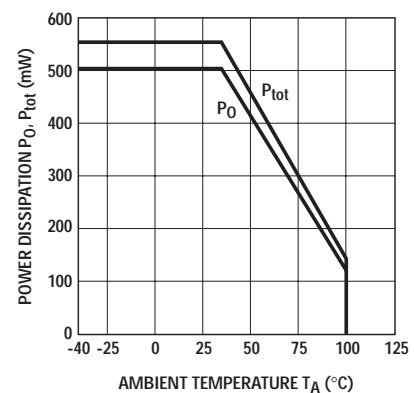


Figure 13. Maximum power dissipation vs. ambient temperature, HCPL-3100.

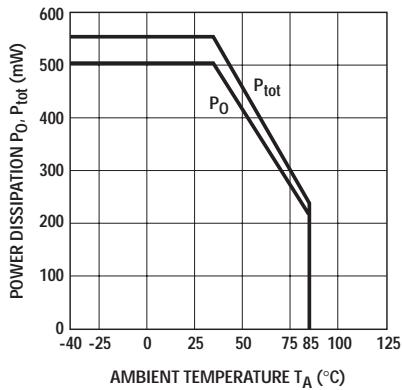


Figure 14. Maximum power dissipation vs. ambient temperature, HCPL-3101.

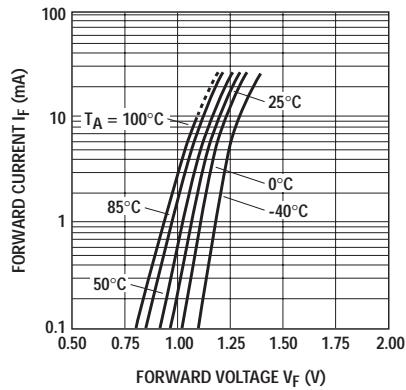


Figure 15. Typical forward current vs. forward voltage, HCPL-3100.

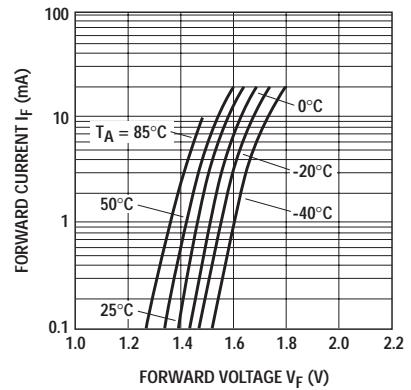


Figure 16. Typical forward current vs. forward voltage, HCPL-3101.

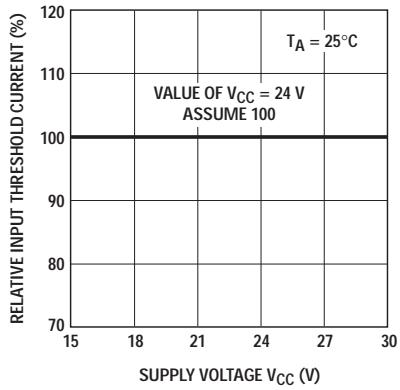


Figure 17. Normalized low to high threshold input current vs. supply voltage, HCPL-3100.

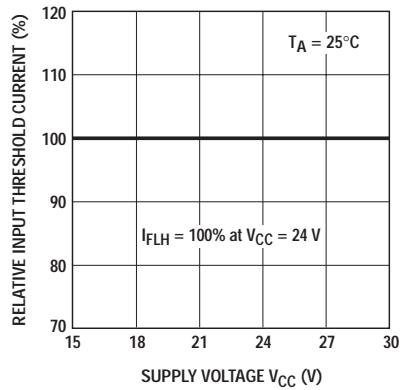


Figure 18. Normalized low to high threshold input current vs. supply voltage, HCPL-3101.

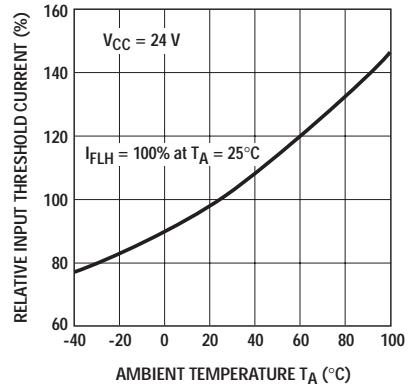


Figure 19. Normalized low to high threshold input current vs. ambient temperature, HCPL-3100.

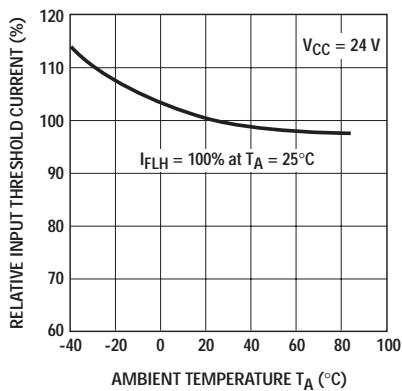


Figure 20. Normalized low to high threshold input current vs. ambient temperature, HCPL-3101.

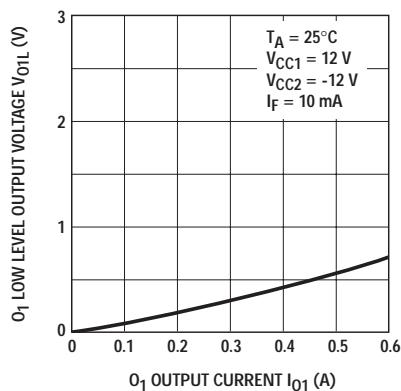


Figure 21. Typical low level output 1 voltage vs. output 1 current, HCPL-3100.

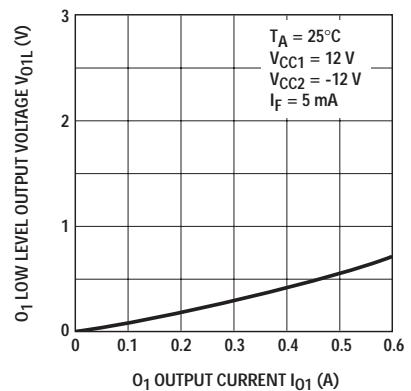
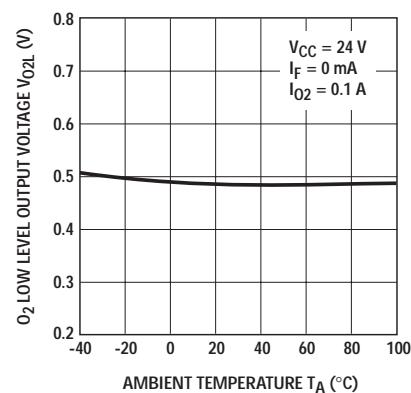
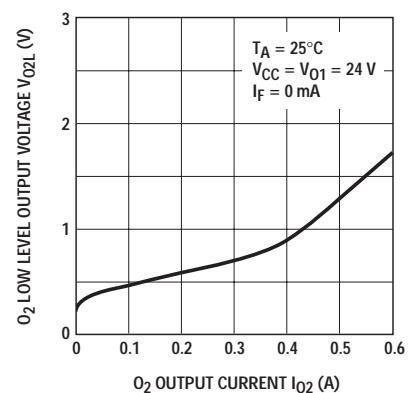
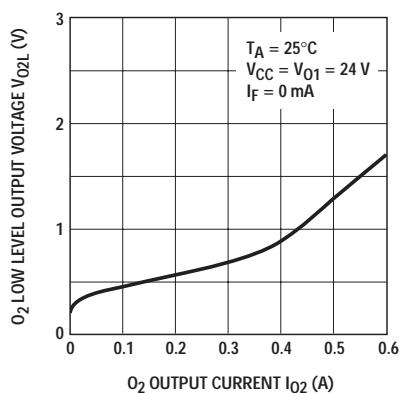
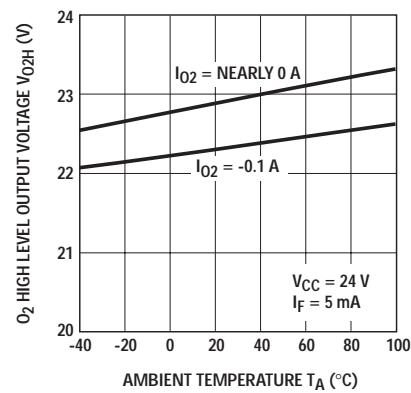
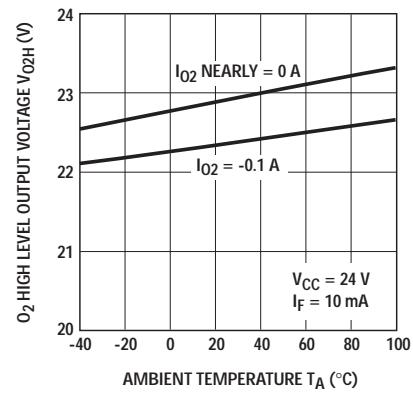
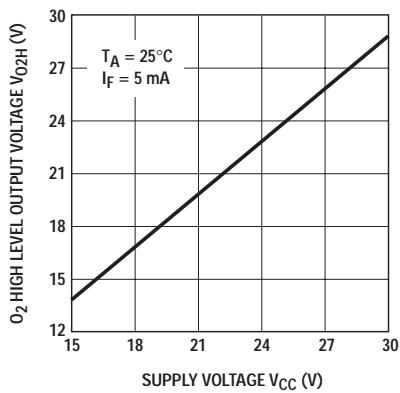
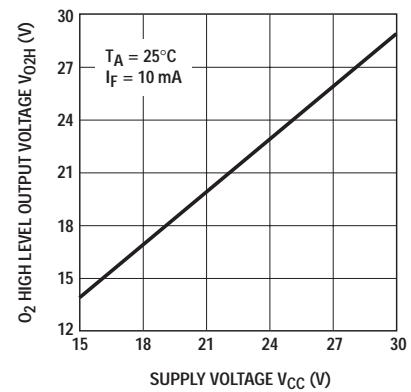
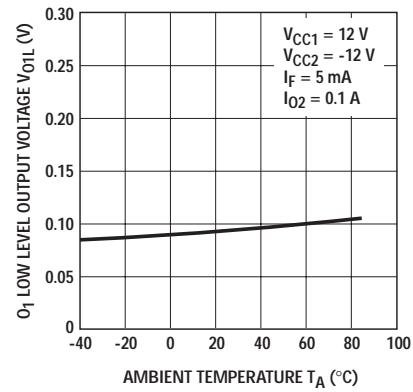
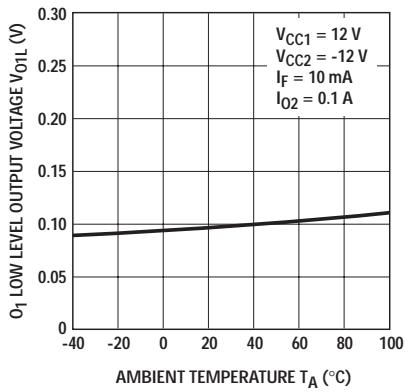


Figure 22. Typical low level output 1 voltage vs. output 1 current, HCPL-3101.



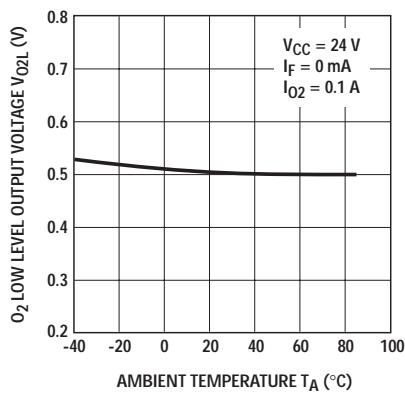


Figure 32. Typical low level output 2 voltage vs. ambient temperature, HCPL-3101.

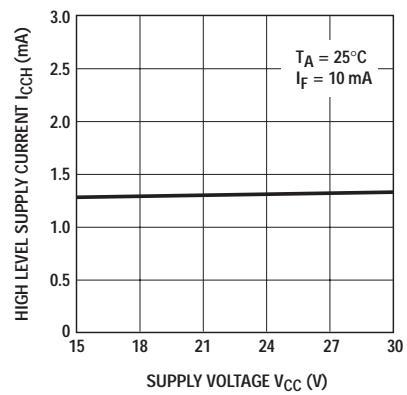


Figure 33. Typical high level supply current vs. supply voltage, HCPL-3100.

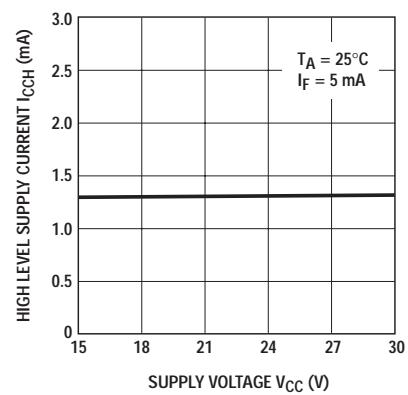


Figure 34. Typical high level supply current vs. supply voltage, HCPL-3101.

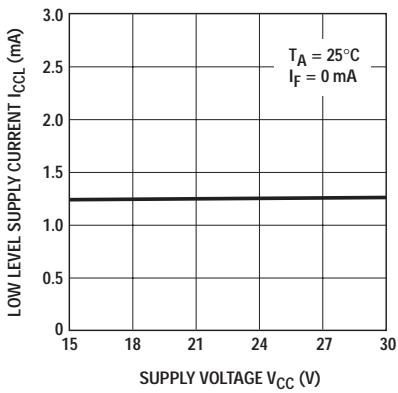


Figure 35. Typical low level supply current vs. supply voltage, HCPL-3100.

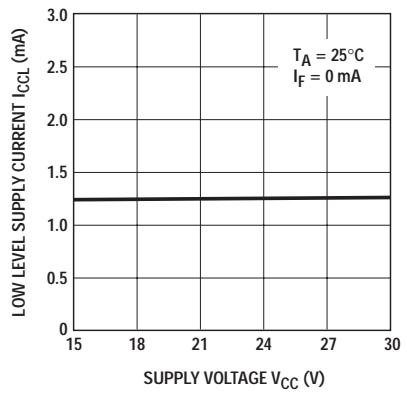


Figure 36. Typical low level supply current vs. supply voltage, HCPL-3101.

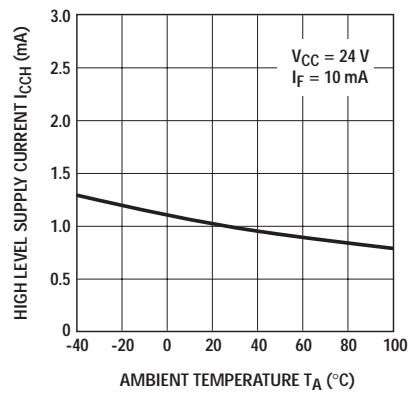


Figure 37. Typical high level supply current vs. ambient temperature, HCPL-3100.

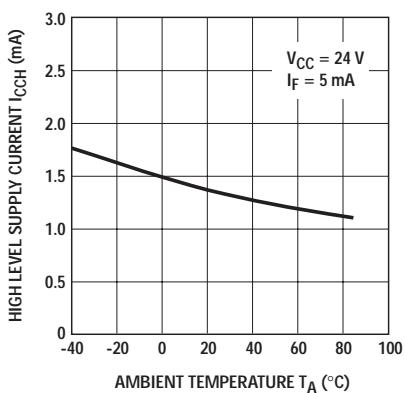


Figure 38. Typical high level supply current vs. ambient temperature, HCPL-3101.

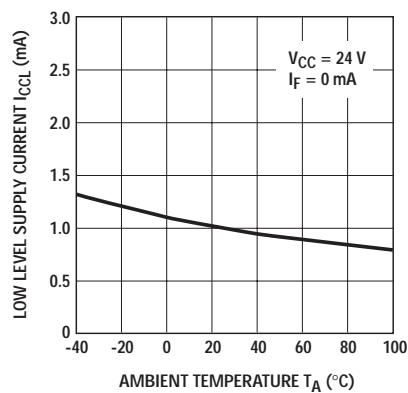


Figure 39. Typical low level supply current vs. ambient temperature, HCPL-3100.

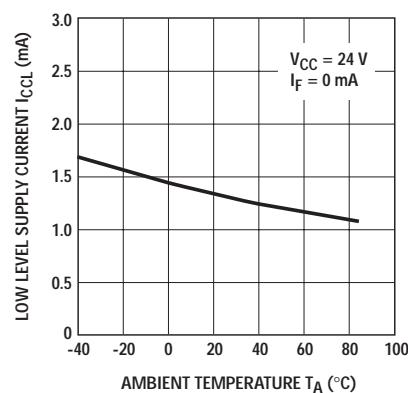
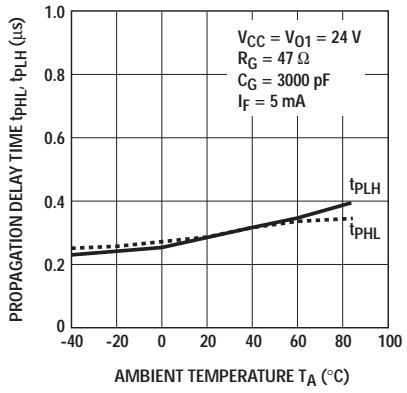
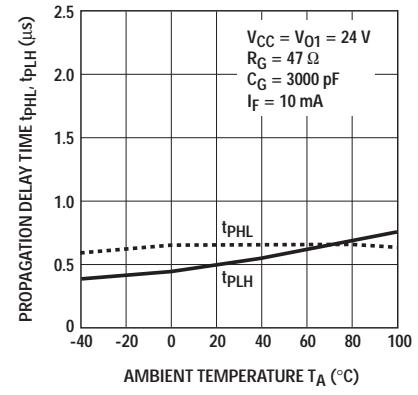
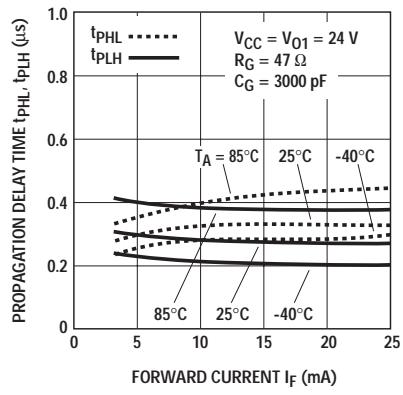
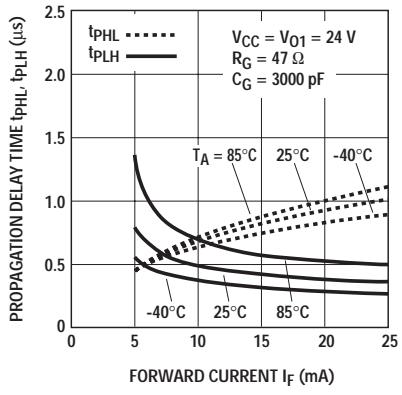


Figure 40. Typical low level supply current vs. ambient temperature, HCPL-3101.



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